

Highlights from Frascati's Detector Development Group activity



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Outline

- Introduction
- R&D on high-rate μ -RWELL
- R&D on tracking µ-RWELL
- R&D on the Hybrid GEM RWELL layout (G-RWELL)
- Summary

The **µ-RWELL**

G. Bencivenni et al., The micro-Resistive WELL detector: a compact spark-protected single amplification-stage MPGD, 2015 JINST 10 P02008



The μ-RWELL is a resistive MPGD, with a GEM derived amplification stage, composed of two elements:

- Cathode
- μ-RWELL PCB:
- a WELL patterned kapton foil (with Cu-layer on top) acting as amplification stage
- a resisitive DLC film with $\rho \sim 50 \div 100 \text{ M}\Omega / \Box$
- a standard readout PCB with pad/strip segmentation



The **"WELL"** acts as a **multiplication channel** for the ionization produced in the drift gas gap.

The **resistive stage** plays a crucial role ensuring the **spark amplitude quenching**, which is **essential for stable operation**.

Drawback: the capability to **stand high particle fluxes** is **reduced but largely recovered** with appropriate **grounding schemes** of the **resistive layer**.





High-rate μ -RWELL for the LHCb experiment

The low-rate layout









Single Resistive Layer (SRL)

- 2-D current evacuation scheme based on a single resistive layer
- DLC grounding around the perimeter of the active area
- limitation for large area: the path of the current towards ground connection depends on the particle incidence point → detector response inhomogeneity → limited rate capability <100 kHz/cm²

High-rate layouts: principle of operation

To overcome the **intrinsic rate limitations** of the **Single Resistive Layout**, it is necessary to introduce a **high-density grounding network** for the resistive stage (DLC).



Single Resistive Layout (SRL) with edge grounding



Segmenting the DLC with conductive micro-strips/dots with a typical pitch of 1cm: a sort of tiling of the active area using a set of smaller SRL.

High-rate layouts evolution

G. Bencivenni et al., The µ-RWELL layouts for high particle rate, 2019 JINST 14 P05014

2018 - 2020

Extensive R&D has been performed to optimize the DLC grounding, enabling the detector to withstand up to 1MHz/cm²



- No grid alignment issues, scalable to large size large dead zone (>15%)
- Easily engineered, because based on SBU technology

High-rate layouts: PEP-DOT

2023

PEP-DOT:

DLC grounding through conductive dots connecting the DLC with pad r/outs

Pad R/O = 9×9 mm²

Grounding:

- Dot pitch = 9mm
- dot rim = 1.3mm
- ~ 97% geometric acceptance









PEP - DOT gain & rate capability (X-ray characterization)



PEP – DOT performance:

- gas gain up to 104
- rate capability (@ 90% gain drop) \sim 10 MHz/cm², measured with different irradiation spot size.





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PEP DOT – time performance (TB – 2023)

FATIC2 based Fee



TB-2023 at H8C with a **preliminary version of the FATIC chip** (developed by Bari Group) in the framework of the R&D for the **LHCb-Muon upgrade**.

The goal is to achieve a time resolution \leq 5 ns in safe operation mode.

PEP DOT – time performance (TB – 2023)

FATIC2 based Fee



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The goal is to achieve a time resolution \leq 5 ns in safe operation mode \rightarrow further R&D needed on both detector & FEE

Tracking $\mu\text{-}RWELL$ for FCC-ee

G. Bencivenni, LNF-INFN

IDEA: pre-shower and muon system

Pre-shower & Muon requirements:

Tiles: 50x50 cm² with X-Y readout

Efficiency ≥ 98%

Space resolution \approx 100 µm (Pre-shower)

 \approx 500 μ m (Muon)

Instrumented Surface/FEE:

pre-shower \rightarrow 130 m², 520 det., 3×10⁵ chs. (0.4 mm strip pitch)

Muon \rightarrow 1500 m², 1520 det., 5×10⁶ ch. (1.2 mm strip pitch)

Mass production \rightarrow Technology Transfer to Industry

FEE Cost reduction \rightarrow **custom made ASIC**



1-D Tracking



With a **0.4 mm strip pitch** and **0.15 mm strip width**, **no effects** were observed **within this resistivity range**. Additionally, **DLC resistivity uniformity is not a critical parameter** for spatial resolution.



Increasing the R/out pitch (0.8, 1.0, 1.2, 1.6 mm) results in a reduction of the spatial resolution.

1-D Tracking (inclined tracks)

For inclined tracks and/or in the presence of high B fields, the charge centroid (CC) gives very poor results due to the very broad spatial resolution on the anode-strip plane

By implementing the μ TPC mode[1] and using the knowledge of the drift time of the electrons (and the drift velocity), each ionization cluster is projected inside the conversion gap, and the track segment in the gas gap is reconstructed.



M. Giovannetti et al., On the space resolution fo the μ-RWELL, 2020 JINST 16 P08036



By combining the CC and μ TPC reconstruction (through a wheighted average) **a resolution below 100** μ **m** could be reached over a wide incidence angle range.



2-D Tracking layouts

The layout with **two separate detectors** equipped with its own r/out is operated at lower gas gain, with respect to the single detector with 2D r/out (COMPASS like).

Tested @ TB2022.

K.Gnanvo et al., NIM 1047 (2023) 167782

u-RWELL - Capacitive Sharing r/out



The charge sharing performed through the capacitive coupling between a stack of layers of pads and the r/out board. Reduce the FEE channels, and the total charge is divided between the X & Y r/out. Tested @ TB2023. Chatode Drift gap X-strips Y-strips

Precursor of the micro-Rgrooves introduced by Zhou Yi

u-RWELL TOP r/out

The **TOP-readout layout** allows to work at **lower gas gain** wrt the «COMPASS» r/out (X-Y r/out decoupled).

X-coordinate on the **TOP** of the amplification stage introduces **dead zone in the active area.**

Tested @ TB2023.

2-D Tracking layouts performance



- 2x1D: spatial resolution < 200um (pitch 0.8 mm), low voltage operating point ~520V, tracking efficiency ~95%
- CS: spatial resolution <200um (pitch 1.2 mm), high voltage operating point, ≥ 600V, tracking efficiency ~ 98%
- **Top r/out:** spatial resolution < 200um (pitch 0.8 mm), low voltage operating point ~520V, tracking efficiency ~70%



The 2D puzzle:

2D tracking at high efficiency requires the detector to be operated at a **gain** \ge **10**⁴ (especially with inclined tracks), While the typical **max-gain of a µ-RWELL is 1**÷**2**×**10**⁴ It's NOT safe to operate a detector in a real experiment close to its max-gain \rightarrow **further R&D needed on detector**

The σ_{T} and 2D puzzle

To address:

- the stringent requirements of the LHCb experiment's muon system upgrade, which demands unprecedented time resolution (σ_T ≤ 5 ns) at high operational stability
- the 2D tracking for non-orthogonal particle tracks

both requiring gas gains larger than 104

We explored innovative detector layouts beyond the conventional μ -RWELL design, based on a hybrid technology, in which a GEM-based pre-amplification stage is combined with the classic μ -RWELL.

The µ-RWELL vs Hybrid (G-RWELL)





Classic μ-RWELL layout Prototype tested: M2R1 - LHCb 250x300 mm² Hybrid layout \rightarrow G-RWELL Prototype tested: 100x100 mm²

Gas gain measurement – w/X-rays



Classic uRWELL (M2R1-LHCb): max gain $\approx 2 \times 10^4$

G-RWELL: max gain >> 10⁴

M2R1 µ-RWELL vs HYBRID – global efficiency



A plateau >98% is reached for a gas gain above 6000.

The gain for PINK (WELL@425V) and RED (WELL@470V) is extrapolated, so the curves doesn't overlap likely for this reason.

M2R1 µ-RWELL vs HYBRID – time resolution



The HYBRID demonstrates better time performance than M2R1 at the same gain, thanks to higher efficiency on the first cluster. Differences among the families at varying HV_WELL values can be attributed to a well-known effect typical of multi-step amplification stage layouts, commonly referred to as the "Biwell effect"

M2R1 μ -RWELL vs HYBRID – time resolution



Time reference: one of the scintillator of the trigger (σ_t <1ns) σ_t : gauss fit core of the Δ_t distribution

M2R1 μ -RWELL vs HYBRID – efficiency in 25ns

M3 - uRWELL



The best performance obtained for a **uRWELL gain around 10**⁴, **close to the typical max gain of the detector**.



The best performance obtained for HV-RWELL 500 – 535 V (gain = 500-1000), and HV-GEM = 450 V (gain = 20) Further improvement expected with transfer gap reduction (3 \rightarrow 2mm)

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Effi(25ns) ≥ 0.9 per single gap allows to have Effi(25ns) ≥ 0.98 per station by using chambers with 4 gaps and requiring at least 2 fired gaps fired per chamber station

Tracking with Hybrid layout (ePIC - INFN Tor Vergata Group)



Summary

The activity of the DDG at the Laboratori Nazionali di Frascati has been focused on the development of MPGDs with and without resistive coupling:

- planar and cylindrical **GEMs**
- planar and cylindrical **µ-RWELLs**

Including

- Design of the detector layouts
- Preparation of some detector components (DLC, cathode, frames ...)
- Technology Transfer to Industry

More recently very stringent requirements in terms of time (LHCb) and spatial resolution (FCC_ee, ePIC, CLAS12 ...) requiring gas gains larger than 10⁴ at high operational stability, pushed the R&D towards a hybrid technology, in which a GEM-based pre-amplification stage is combined with the classic µ-RWELL.

The G-RWELL shows very interesting performance:

- very stable operation at gas gains >> 10⁴ (approaching without instability 10⁵)
- The time performance improved to as low as **3.8 ns** (a record for a single MPGD detector gap)
- Preliminary results of the 2D tracking features, studied by the ePIC- Tor Vergata group in the last joint TB, show very good spatial performance ($\sigma_x \sim 70 \mu m$ for orthogonal track incidence ... waiting for final analysis)



SPARE SLIDES

G. Bencivenni, LNF-INFN

Test Beam setup





A special thanks to INFN LNF, Rome2, and Bari LHCb groups for the support during the beam test.

TB area: PS-T10 w/ 5 GeV muons

G. Bencivenni, LNF-INFN



Ionisation

The particle ionises in both the drift gap and the transfer gap



Ionisation

The particle ionises in both the drift gap and the transfer gap

GEM or RWELL

Electron from the drift gap \rightarrow amplified from the **GEM** (gain **20**) Electrons from the transfer gap \rightarrow amplified by the **WELL** (gain **2000**)



Ionisation

The particle ionises in both the drift gap and the transfer gap

GEM or RWELL

Electron from the drift gap \rightarrow amplified from the **GEM** (gain **20**) Electrons from the transfer gap \rightarrow amplified by the **WELL** (gain **2000**)

GEM + RWELL

After a drift time in the "Transfer gap", the electrons preamplified by the GEM reach the RWELL, and get amplified again.

ightarrow Total gas gain 40'000


Transfer scan Hybrid HYB_U



Sigmat vs E_transfer (Thr = 6fC_5fC - E_drift = 3.5 kV/cm)

G. Bencivenni, LNF-INFN

Gas gain measurement – w/X-rays



Classic uRWELL (M2R1-LHCb): max gain $\approx 2 \times 10^4$

G-RWELL: max gain $>> 10^4$

Majority

Majority – w/ Bkg

Analytic computation



LHCb case \rightarrow f_meas & f_corr from "2023/03" \rightarrow equations from "Palutan 2024/12" Case "2 over 3" not present (I don't know the formula)

Majority – w/ Bkg – AND 4 stations – DT 100ns



Analytic computation

Technology spread

In the last years there has been a significant spread of the technology among several research groups working on Nuclear and Sub-Nuclear experiments

- 1. CLAS12 @ JLAB (USA): the upgrade of the muon spectrometer
- 2. EPIC @EIC (BNL USA): endcap tracker disks based on a hybrid GEM+ μ RWELL technology
- 3. X17 @ n_TOF EAR2 (CERN): TPC with a µRWELL based amplification stage, for the detection of the X17 boson
- 4. TACTIC @ YORK Univ. (UK): radial TPC for detection of nuclear reactions with astrophysical significance
- 5. Muon collider: R&D for a digital hadron calorimeter
- 6. CMD3 (RU): GEM+ μ RWELL disk for the upgrade of the tracking system
- 7. UKRI (UK): thermal neutron detection with pressurized ³He-based gas mixtures

















Rate capability vs spot-size & detector size

Comparison between a model of the resistive stage and measurements of the rate capability for SRL.

1. detectors with same size (d) but different resistivity exhibit a rate capability scaling as the inverse of their resistivity.

2. for the SRL, increasing the active area **from 10x10 cm² to 50x50 cm²** the rate capability should go **down few kHz/cm²**.

3. By using a DLC ground sectoring every 10 cm, large (50x50cm²) detectors could achieve rate capability up to 100kHz/cm² (with X-ray).

> Different primary ionization ⇒ Rate Cap._{m.i.p.} = 3×Rate Cap._{X-ray}



LHCb upgrade II (Run5 – Run6)



LHCb muon apparatus Run5 – Run6 detector requirements

- Rate up to **1 MHz/cm²** on detector single gap
- Rate up to 700 kHz per electronic channel
- Efficiency quadrigap >=99% within a BX (25 ns)
- Stability up to **1C/cm²** accumulated charge in 10y at M2R1, G=4000

Detector size & quantity (4 gaps/chamber - redundancy)

• R1÷R2: 576 detectors, size 30x25 to 74x31 cm², 90 m² detector (130 m² DLC)







Rates	(kHz/cm^2)	M2	M3	M4	M5
	R1	749	431	158	134
	R2	74	54	23	15
	R3	10	6	4	3
	$\mathbf{R4}$	8	2	2	2
Ar	$rea~(m^2)$	M2	M3	M4	M5
	R1	0.9	1.0	1.2	1.4
	R2	3.6	4.2	4.9	5.5
	R3	14.4	16.8	19.3	22.2
	R4	57.6	67.4	77.4	88.7

G. Bencivenni, LNF-INFN,

High-rate layouts: DRL



G. Bencivenni et al., The µ-RWELL layouts for high particle rate, 2019 JINST 14 P05014





Double Resistive Layer

- Two stacked resistive layers with a double matrix of conductive vias
- **3-D current** evacuation
- Rate capability > 10MHz/cm²
- Complex manufacturing not easily engineered

High-rate layouts: SG







Mip Flux[Hz/cm²]



The Silver Grid layout

- Single DLC layer
- 2-D current evacuation through conductive grid on the DLC layer
- rate capability > 10MHz/cm²
- Easily engineered, BUT complex Cu+DLC sputtering/alignment

High-rate layouts: SG



G. Bencivenni et al., The µ-RWELL layouts for high particle rate, 2019 JINST 14 P05014

0.4

0.5

0.6

0.7





0.8

0.9

Position (cm)

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High-rate layouts: PEP groove



2021/22



PEP (Patterning – Etching – Plating)

- Single DLC layer
- 2-D current evacuation: conductive grid by etching from the top Cu, through the kapton foil down to the DLC
- No grid alignment issues, scalable to large size large dead zone (>15%)
- Easily engineered, because based on SBU technology

G. Bencivenni, LNF-INFN,

High-rate layouts: PEP layouts comparison

2022

PEP-Groove: DLC grounding through conductive groove to ground line

Pad R/O = $9 \times 9 \text{mm}^2$

Grounding:

- Groove pitch = 9mm

11-48 2700

L2=48,27µm

- width = 1.1mm
- \rightarrow 84% geometric acceptance

Cu 0.142 mm

Dead area 1.1 mm

DOCA 0.48 mn

L3=81,53µr

L4=123.37m

L6=149.12





PEP-DOT:

DLC grounding through conductive dots connecting the DLC with pad r/outs Pad R/O = 9×9 mm² Grounding: - Dot pitch = 9mm

- dot rim = 1.3mm
- \rightarrow 97% geometric acceptance



DOT \approx plated blind vias



0.175 mm



Groove vs DOT (X-ray characterization)



Groove vs DOT (TB-2023)

APV25 based Fee









Cross-section of a μ -RWELL with a conductive line on the DLC (High-Rate scheme).

The concept of **DOCA** (Distance-Of-Closest-Approach) before discharge is fundamental for the **stability** of the detector.

The **DOCA** is defined as the **distance between** the edges of the **conductive lines** and its **closest amplification hole**.



The **DOCA (before discharge)** as a function of the DLC **resistivity**, for different **voltages**. The study has been performed with a custom tool, with two thin conductive movable tips.



Prepreg thickness optimization





28μm thick prepreg maximize both the **amplitude of the signa**l induced on the pad readout, and **S/N ratio** (measurement done with APV25)

Low XO cylindrical µ-RWELL



Exploiting the **flexible characteristic of the amplification stage** of the μ -RWELL, as well as the readout (to which it is coupled through the resistive DLC stage), we developed **a low-mass modular Inner Tracker for low-energy positron-electron colliders (SCTF)** \rightarrow Cylindrical μ -RWELL (C-RWELL).

- N.2 small gap B2B C+layers \rightarrow 1.72% X₀
- 2 × 1 cm gas gap/B2B device
- 4 cm global sampling gas



micro-TPC readout mode allowing space resolution of $O(100 \ \mu m)$ for inclined tracks (on the radial view)

Irradiation test of DLC and µ-RWELL

Bare DLC foils

- **DLC foils**: monitoring of the resistivity of two foils under x-ray irradiation.
- **μ-RWELL detectors**: prototypes irradiated with different radiation.



μ-RWELL DETECTORS



FATIC2 block diagram



Preamplifier features:

- CSA operation mode
- Input signal polarity: positive & negative
- Recovery time: adjustable

CSA mode:

- Programmable Gain: 10 mV/fC ÷ 50 mV/fC
- Peaking time: 25 ns, 50 ns, 75 ns, 100 ns

Timing branch:

- ✓ Measures the arrival time of the input signal
- ✓ Time jitter: 400 ps @ 1 fC & 15 pF (Fast Timing MPGD)

Charge branch:

- ✓ Acknowledgment of the input signal
- Charge measurement: dynamic range > 50 fC, programmable charge resolution



Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401-404

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Development of μ -RWELL detectors for the upgrade of the tracking system of CMD-3 detector

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ARTICLE INFO

Keywords: Tracking detectors Micro-RWELL Micro-pattern gas detectors ABSTRACT

An upgrade of tracking system of Cryogenic Magnetic Detector (CMD-3) is proposed using microresistive WEIL technology. CMD-3 is a general purpose detector operating at the VEPP-2000 collider at Budker Institute of Nuclear Physics and intended for studies of light vector mesons in the energy range between 0.3 GeV and 2 GeV. The new subsystem consists of double-layer cylindrical detector and the end-cap discs. Two prototypes, micro-RWELL and micro-RWELL-GEM were built and tested. Gas amplification of micro-RWELL detector was measured with several gas mixtures and maximum gain between 20000 and 30000 was observed. However, maximum gain is fluctuating from measurement to measurement by a factor of 2 and thus a safety margin of 2–3 is needed to provide reliable operation of the device. In order to increase the signal GEM was added to micro-RWELL, new prototype was tested with the same gas mixtures and gains above 10⁵ have been demonstrated. Time resolution achieved for both prototypes are 7 ns for micro-RWELL and 4 ns for micro-RWELL-GEM.

L. Shekhtman, Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401-404



Drift Gap: Shekhtman 3mm – LNF+Roma2 6mm



Transfer Gap: Shekhtman 3mm – LNF+Roma2 3mm



Developed for CMD3 upgrade disks (4 sectors 50×50cm²)

The GEM **must be** stretched: sizes larger than 50×50cm² could be critical (depending on the gas gaps size).

2-D Tracking layouts performance



Fit Gauss-2D sigmaX = 85μm sigmaY = 121μm



Fit Gauss-2D sigmaX = 142 μm sigmaY = 147 μm



Fit Gauss-2D sigmaX = 173 μm sigmaY = 250 μm 20. PROFILE

211. RESIDIAL

µ-RWELL + GEM: gas gain





Fig. 4. Gain as a function of voltage on the top electrode of μ -RWELL for different gas mixtures. Voltage across the drift gap is 500 V.

Fig. 5. Gain as a function of voltage on the top electrode of μ -RWELL for GEM voltages providing additional gain of 50–100 and for different gas mixtures. Voltage across the drift gap is 500 V.

L. Shekhtman, Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401-404

The µ-RWELL as neutron detector





Custom FEE by LNF electronic pool based on CR-200 & CR-110



Cylindrical-RWELL for low-momentum experiments

G. Bencivenni, LNF-INFN

Low X_0 Cylindrical μ -RWELL



By exploiting the **flexible characteristic of the amplification stage** of the μ -RWELL, as well as the readout, we developed **a low-mass (0.6% X₀) modular Inner Tracker** for **low-energy positron-electron colliders**, exploiting the innovative **Cylindrical \mu-RWELL (C-RWELL) technology.**

- From standard micro-RWELL technology on rigid PCB supports we developed a full flexible detector tile
- Three of such flexible detector tiles have been glued on composite/foam roof-tiles, then mounted on the anode cylindrical support
- A full cylindrical-cathode will close (externally) the detector



The roof tile assembly



The roof tile is composed of a **Structural Adhesive Film (30 µm)** coupled to **a layer of Millifoam® (2 mm)** where the flexible PCB is glued, under vacuum, with epoxy.



The roof tile Millifoam® support



Gluing the μ -RWELL-PCB onto the roof tile, followed by an epoxy curing cycle under vacuum.



The **flexible μ-RWELL PCBs** produced at CERN-EP-DT MPT Workshop. Each foil is divided in four HV sectors



The final roof tile is coupled to the anode support

The final assembly



The final assembly didn't require a highly sophisticated sliding machine, thanks to the large distance (10 mm) between the roof tiles and the internal surface of the cathode. The tile gluing and the detector assembly took 14 days.





The detector completed



Vietnamese dinner with Huong (in Rome)

The assembly

G. Bencivenni, LNF-INFN,

Cosmic ray test



We set up a **tracking system** with four 1D μ -RWELL (400 μ m strip pitch \rightarrow ~100 μ m **tracking** resolution) All detectors were equipped with **APV25** and flushed with **Ar/CO₂/CF₄ 45/15/40**.



C-RWELL test with cosmics.



The technology remains in the drawer because the **collaboration with the SCTF group in Russia** has obviously been **stopped by the war.**

Technology Transfer to Industry

G. Bencivenni, LNF-INFN

Manufacturing high-rate layouts

The **µ-RWELL_PCB is a rigid-flex PCB** based on **SBU technology**, that is **compatible with standard industrial processes**.

The **ELTOS** is the industrial partner **involved in the manufacturing of the μ-RWELL**.

The **ELTOS SpA** was founded in 1980 in Arezzo, Italy.

The Company has a large experience in the construction of MPGDs, including technologies such as Thick-GEM (THGEM) and MicroMegas.

The **involvement of a private industry** in this R&D **opens the way** for the use of μ -RWELL technology **across various fields of applications.**







Detector Manufacturing flow chart





Detector manufacturing steps



Step 0 – Detector PCB design @ LNF



1105

NF

- Step 1 CERN_INFN DLC (C.I.D) sputtering machine installed @ CERN
 - In operation since Nov. 2022
 - Production by LNF-INFN technical crew
- Step 2 Producing readout PCB by ELTOS
 - pad/strip readout

Step 3 – DLC patterning by ELTOS

• photo-resist \rightarrow patterning with BRUSHING-machine

Step 4 – DLC foil gluing on PCB by ELTOS

• Large press available, up to 16 PCBs workable simultaneously

Step 5 – Top copper patterning by CERN

Cu amplification holes image and HV connections by Cu etching



- Step 6 Amplification stage patterning by CERN
 - PI etching \rightarrow amplification-holes

Step 7 – Electrical cleaning and detector closure @ **CERN**

G. Bencivenni, LNF-INFN,





DLC sputtering



The CID (CERN-INFN-DLC) sputtering machine, a joint project between CERN and INFN, is used for preparing the **base material of the detector**. The potential of the DLC sputtering machine is:

- Flexible substrates up to 1.7×0.6m2
- Rigid substrates up to 0.2×0.6m2

In 2023, the activity on CID focused on the tuning of the machine on small foils with good results in terms of **reproducibility and uniformity**.

In **2024**, the challenge has been the **sputtering of large foils**:

- DLC+Cu sputtering on 0.8×0.6m2 successfully done (May/June 2024)
- DLC on 1.7×0.6m2 large 0/50/0 Apical foils successfully done (June 2024)
- DLC on 1.7×0.6m2 large 5/50/0 Apical foils still to be done (July 2024)









Ar 150 sccm, C_2H_2 3 sccm, p_{proc} 2E-3 mbar
Detector manufacturing at ELTOS (I)

Step 2 (@ ELTOS)

1) PCB production

Step 3 (@ ELTOS)

- 1) Photoresist lamination for DLC protection
- 2) Photoresist UV-exposure
- 3) Photoresist developing
- 4) DLC patterning with brushing machine











DLC



Detector manufacturing at ELTOS (II)

Step 4: The final manufacturing operation carried out at ELTOS is the **coupling of the** DLC foil and the PCB through a layer of prepreg.

N. 16 prototypes of micro-RWELL were made with 4 different prepreg thicknesses $(\oplus 1 \text{ special}).$

The test, beside validating the whole manufacturing process (ELTOS \oplus CERN), allowed for the study of the dependence of the induced signal amplitude as a **function of the readout capacitance** wrt the amplification stage.





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Electrical Hot Cleaning



At the end of the manufacturing process at CERN, a **conditioning procedure** is performed:

- Standard PCB washing
- Electrical cleaning in dry air (90°C in an oven) from 300
 V to 680 V (each step with current < 1 nA)
- Detector closure and final test at 600 V in ambient air

Pilot co-production test



The 16 co-produced prototypes have been extensively tested with X-rays:

- 15/16 are fine
- 1/16 needs to be re-cleaned

Production yield > 93%

Co-production pilot results (I)



- 16 co-produced protos have been delivered and tested
- 10/16 (LNF) + 5/16 (CERN) are fine
- 1/16 should be re-cleaned



Characterized with X-ray gun \rightarrow Gas gain measurement

Max-gain vs resistivity



- 16 co-produced protos have been delivered and tested
- 10/16 (LNF) + 5/16 (CERN) are fine
- 1/16 should be re-cleaned



The maximum gain is larger for $\rho \ge 40$ MOhm/square

Max-gain: large size vs small size

CS_01 13 MOhm/sq, area 46x38 cm² M2R1 260 MOhm/sq, area 30x25 cm²



For large-size detectors, the max-gain increases with the DLC resistivity, although, compared to the small-size detectors, the gain curve for the larger size is shifted towards lower values.

G. Bencivenni, LNF-INFN